规格書

SPECIFICATION

Customer：_____

Part Name: E-CAP

SPEC： SP Series

Part NO.： ALL

Date： 2017-11-22

CUSTOMER SIGN		

TOPAZCON	
DRAWING	RATIFY
黃峰	陳慶

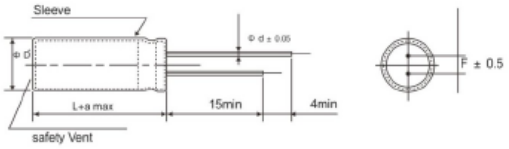
SP Series

- Miniaturized, Low ESR and low impedance.
- Suitable for use in high ripple current capability.
- Load life 4,000 hours at 105 ℃

SPECIFICATIONS

Item	Performance Characteristics						
Category Temperature Range	-40 ~ +105 ℃						
Working Voltage Range	10 ~ 100Vdc						
Capacitance Range	68 ~1,800 μF						
Capacitance Tolerance	± 20%						(at20 ℃ and 120Hz)
Dissipation Factor (tanδ)	Rated Voltage (V)	10	16	25	35	100	
	Tanδ(Max)	0.19	0.16	0.14	0.12	0.08	
	The above values should be increased by 0.02 for every additional 1000μF						(at 20 ℃ , 120Hz)
Leakage Current	I=0.01CV or 3μA whichever is greater I : Leakage current (μA) C : Rated capacitance (μF) V : Rated voltage (V)						(at 20 ℃ , 2minutes)
Endurance	The following requirements shall be satisfied when the capacitor are restored to 20 ℃ after the rated voltage applied for 4,000 hours at 105 ℃ .						
	Capacitance change	≤ ± 25% of the initial value					
	Dissipation factor(tanδ)	≦ 200% of the specified value					
	Leakage current	≦ specified value					
Shelf Life	The following requirements shall be satisfied when the capacitor are restored to 20 ℃ after exposing them for 500 hours at 105 ℃ without voltage applied.						
	Capacitance change	≈ ± 25% of the initial valve					
	Dissipation factor(tanδ)	≤ 200% of the specified value					
	Leakage current	≦ 200% of the specified value					

DIMENSIONS[MM]



Φ D	12.5 x 12
Φ D	Φ D+0.5Max
Φ d	0. 6
F	5.0
a	L + 1.0 Max

RATED RIPPLE CURRENT MULTIPLIERS

Frequency Multipliers

Vdc	Cap.(uF)	Frequency (Hz)			
		120	1K	10K	100K
10 ~ 100	≥68	0.30	0.65	0.85	1.00
	82 ~ 220	0.50	0.70	0.90	1.00
	330 ~ 820	0.60	0.75	0.95	1.00
	1000 ~ 1800	0.70	0.80	0.98	1.00

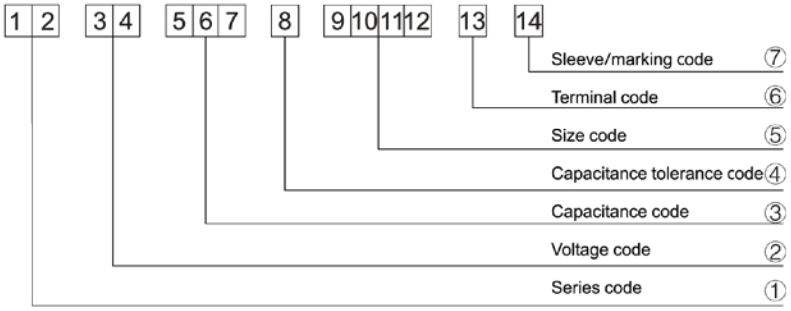
SP Series

● Case size & Permissible rated ripple current:

Nominal capacitance (uF)	10V		16V		25V	
	Case size DΦ×L (mm)	Max. Rated ripple current @105℃ 100kHz (mA rms)	Case size DΦ×L (mm)	Max. Rated ripple current @105℃ 100kHz (mA rms)	Case size DΦ×L (mm)	Max. Rated ripple current @105℃ 100kHz (mA rms)
560					12.5×12	1150
680					12.5×12	1200
1000			12.5×12	1300		
1200			12.5×12	1400		
1500	12.5×12	1260				
1800	12.5×12	1300				

Nominal capacitance (uF)	35V		100V	
	Case size DΦ×L (mm)	Max. Rated ripple current @105℃ 100kHz (mA rms)	Case size DΦ×L (mm)	Max. Rated ripple current @105℃ 100kHz (mA rms)
68			12.5×12	350
82			12.5×12	420
390	12.5×12	1050		
470	12.5×12	1100		

Part Number System



① Series code

Series name	Code	
	1	2
SM	S	M
SS	S	S
SH	S	H
SP	S	P
NP	N	P
LL	L	L
RD	R	D
RE	R	E
RT	R	T
RF	R	F
RG	R	G
RJ	R	J
RR	R	R
LF	L	F
LJ	L	J
LR	L	R
LG	L	G

② Voltage code

WV (Vdc)	Code	
	3	4
4	0	G
6.3	0	J
10	1	A
16	1	C
25	1	E
35	1	V
50	1	H
63	1	J
80	1	K
100	2	A
160	2	C
200	2	D
250	2	E
350	2	V
400	2	G
450	2	W
500	2	H

③ Capacitance code

Cap (uF)	Code		
	5	6	7
0.1	R	1	0
0.22	R	2	2
0.33	R	3	3
0.47	R	4	7
1	1	R	0
2.2	2	R	2
3.3	3	R	3
4.7	4	R	7
6.8	6	R	8
10	1	0	0
22	2	2	0
33	3	3	0
47	4	7	0
100	1	0	1
220	2	2	1
330	3	3	1
470	4	7	1
560	5	6	1
1000	1	0	2
1500	1	5	2
2200	2	2	2
3300	3	3	2
4700	4	7	2
6800	6	8	2
10000	1	0	3
15000	1	5	3

④ Capacitance tolerance code

Tol. (%)	Code
	8
−5 ~ +5	J
−10 ~ +10	K
−20 ~ +20	M

⑤ Size code

ΦD × L (mm)	Code			
	9	10	11	12
3 × 5	0	3	0	5
4 × 5	0	4	0	5
5 × 5	0	5	0	5
6.3 × 5	0	6	0	5
4 × 7	0	4	0	7
5 × 7	0	5	0	7
6.3 × 7	0	6	0	7
8 × 7	0	8	0	7
5 × 11	0	5	1	1
6.3 × 11	0	6	1	1
8 × 12	0	8	1	2
8 × 16	0	8	1	6
10 × 12	1	0	1	2
10 × 16	1	0	1	6
8 × 20	0	8	2	0
10 × 20	1	0	2	0
13 × 20	1	3	2	0
13 × 25	1	3	2	5
16 × 25	1	6	2	5
16 × 32	1	6	3	2
16 × 36	1	6	3	6
18 × 32	1	8	3	2
18 × 36	1	8	3	6
18 × 40	1	8	4	0

⑦ Sleeve/Marking code

Sleeve/Marking	Code
	14
PET	T
Black	B
Yellow	Y
Ink Green	I
Pea Green	P
Orange	O

⑥ Terminal code

Specification	Code
	13
Bulk packing	0
Φ4–8Taping	T1
	T2
	T2
Φ10–18Taping	T3
Lesd Cut	F
	C
	R
	L
	M
	S
	B
	K

Lead Forming

Taping Specifications

Fig.1 Code:T1

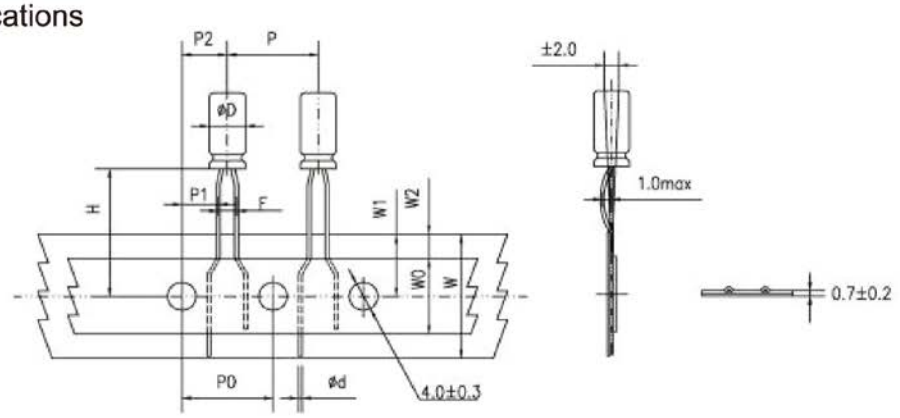


Fig.2Code:T2

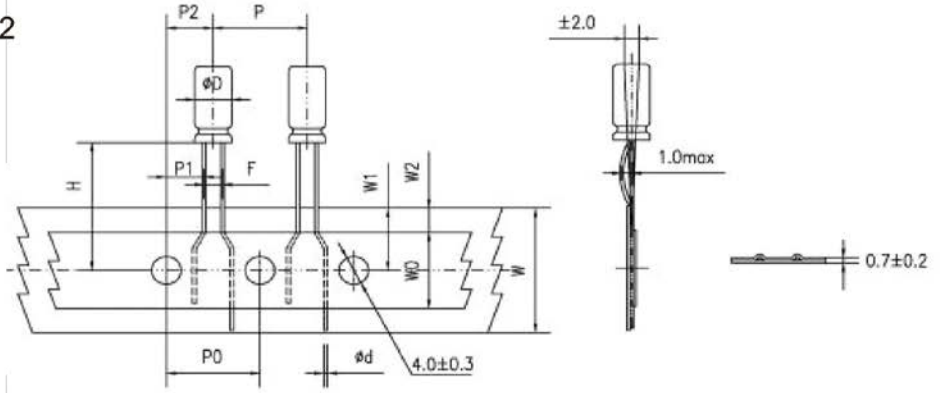


Fig.3 Code:T2

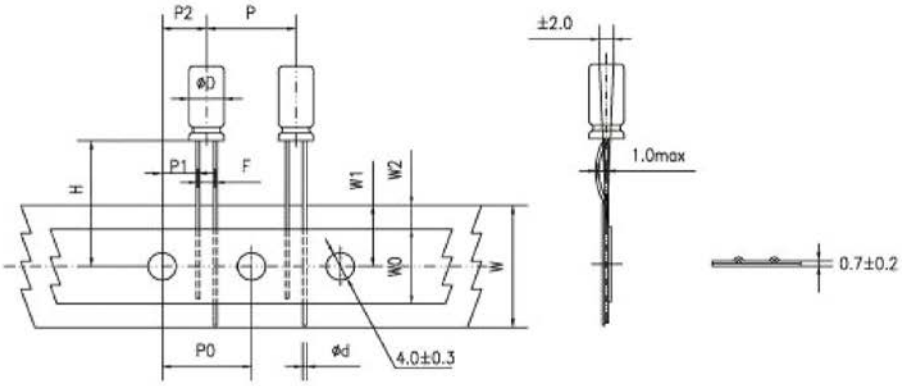
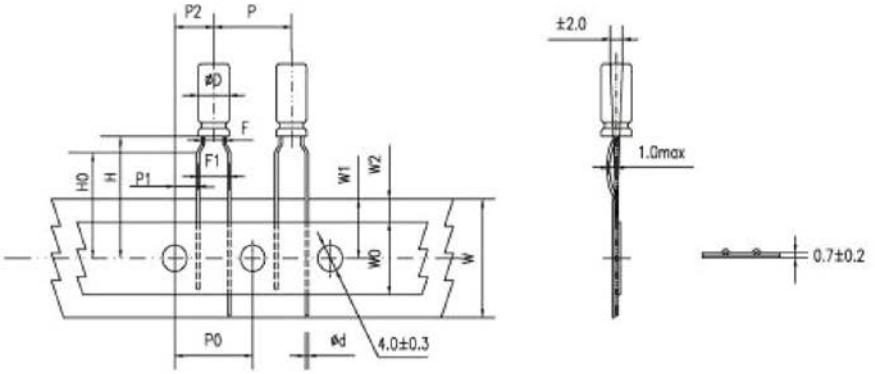


Fig.4 Code:T3



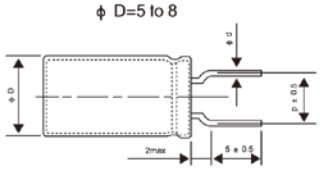
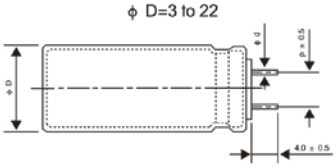
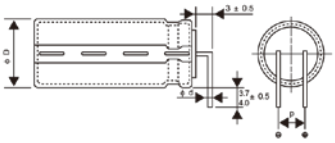
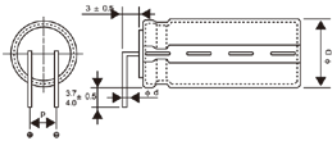
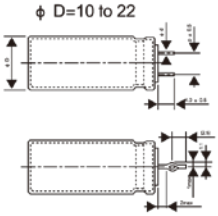
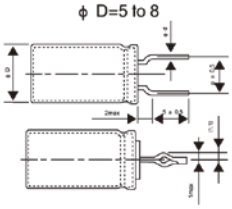
Specification Fig.1 & Fig.2 & Fig.3

Iterms	Symbol	CASE SIZE													Tolerance
		4 × 5 4 × 7		5 × 5 5 × 7		5x11		6.3x5	6.3x7 6.3x9	6.3x11 6.3x12	8x5/7 8x9/11 8x11.5 8x12	8x16 8x20	10x9/12 10x12.5 10x13/16 10x20/25		
Pin Code		T1	T2	T1	T2	T1		T2	T2	T2	T2	T2	T2		
Lead wire diameter	ϕd	0.45		0.45		0.5		0.45	0.5	0.5	0.45/0.5	0.6	0.6		± 0.05
Pitch of body	P	12.7		12.7		12.7		12.7	12.7	12.7	12.7	12.7	12.7		± 1.0
Feed hole pitch	PO	12.7		12.7		12.7		12.7	12.7	12.7	12.7	12.7	12.7		± 0.2
Hole center to lead distance	P1	5.1	5.6	5.1	5.35	5.1	5.35	5.1	5.1	5.1	4.6	4.6	3.85		± 0.7
Feed hole center to body center distance	P2	6.35		6.35		6.35		6.35	6.35	6.35	6.35	6.35	6.35		± 1.0
Lead to lead distance	F	2.5	1.5	2.5	2.0	2.5	2.0	2.5	2.5	2.5	3.5	3.5	5.0		± 0.5
Height of body from tape center	H	18.5		18.5		18.5		18.5	18.5	18.5	18.5	18.5	18.5		± 0.75
Base tape width	W	18.0		18.0		18.0		18.0	18.0	18.0	18.0	18.0	18.0		± 0.5
Adhesive tape width	WO	11.0		11.0		11.0		11.0	11.0	11.0	11.0	11.0	11.0		min
Hole positron	W1	9.0		9.0		9.0		9.0	9.0	9.0	9.0	9.0	9.0		+0.75 −0.5
Hole down tape position	W2	3.0		3.0		3.0		3.0	3.0	3.0	3.0	3.0	3.0		max

Specification Fig.4

Iterms	Symbol	CASE SIZE									Tolerance
		4 × 5 4 × 7	5 × 5	5 × 7	5 × 11	6.3 × 5	6.3 × 7 6.3 × 9	6.3 × 11 6.3 × 12	8 × 5/7 8 × 9/11 8 × 11.5/12	8 × 16 8 × 20	
Pin Code		T3	T3	T3	T3	T3	T3	T3	T3	T3	
Lead wire diameter	ϕd	0.45	0.45	0.45	0.5	0.45	0.5	0.5	0.45/0.5	0.6	± 0.05
Pitch of body	P	12.7	12.7	12.7	12.7	12.7	12.7	12.7	12.7	12.7	± 1.0
Feed hole pitch	PO	12.7	12.7	12.7	12.7	12.7	12.7	12.7	12.7	12.7	± 0.2
Hole center to lead distance	P1	3.85	3.85	3.85	3.85	3.85	3.85	3.85	3.85	3.85	± 0.7
Feed hole center to body center distance	P2	6.35	6.35	6.35	6.35	6.35	6.35	6.35	6.35	6.35	± 1.0
Lead to lead distance	F	1.5	2.0	2.0	2.0	2.5	2.5	2.5	3.5	3.5	± 0.5
Lead to lead distance	F1	5.0	5.0	5.0	5.0	5.0	5.0	5.0	5.0	5.0	+0.8 −0.2
Height of body from tape center	H	18.5	18.5	18.5	18.5	18.5	18.5	18.5	18.5	18.5	± 0.75
Lead wire clinch height	HO	16.0	16.0	16.0	16.0	16.0	16.0	16.0	16.0	16.0	± 0.5
Base tape width	W	18.0	18.0	18.0	18.0	18.0	18.0	18.0	18.0	18.0	± 0.5
Adhesive tape width	WO	11.0	11.0	11.0	11.0	11.0	11.0	11.0	11.0	11.0	min
Hole position	W1	9.0	9.0	9.0	9.0	9.0	9.0	9.0	9.0	9.0	+0.75 −0.5
Hole down tape position	W2	3.0	3.0	3.0	3.0	3.0	3.0	3.0	3.0	3.0	max

Lead Forming & Cut:

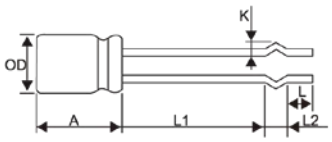
Lead comfiguration:F	Lead comfiguration:C
ϕ D=5 to 8 	ϕ D=3 to 22 
Lead comfiguration:R	**Lead comfiguration:L**
ϕ D=10 to 22 	ϕ D=10 to 22 
Lead comfiguration:M	**Lead comfiguration:S**
ϕ D=10 to 22 	ϕ D=5 to 8 

LEAD SPACING&RECOMMENDED PCB DIMENSIONS

(mm)

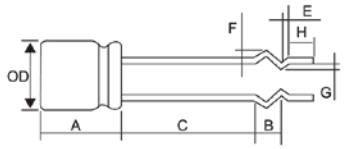
ϕD / Dimensionc	ϕd	p	PC Board		Lead Configuration
			Hole diame ter	Thickness	
5	0.5	5.0	0.8	1.6	F C S
6.3	0.5	5.0	0.8		
8	0.5/0.6	5.0	1.0		
10	0.6	5.0	1.0	1.6	C M R L
12.5	0.6	5.0	1.0		
16	0.8	7.5	1.2		
18	0.8	7.5	1.2		
20	0.8	7.5	1.2		
22	0.8	10.0	1.2		

Lead comfiguration:B



⌀D	L1	L2	K	A	L
5	17.5–19.5	2.6	1.9	10.0–15.0	3.0–5.0
6.3	17.5–19.5	2.6	1.9	10.0–16.0	
8	12.0–14.0	2.5	1.3	10.0–20.0	
8	13.5–15.5	2.5	1.5		
8	13.0–15.0	3.0	1.5		
8	19.5–21.5	3.0	1.5		
8	21.0–23.0	3.0	1.5		
10	7.5–9.5	2.5	1.7	10.0–25.0	
10	17.0–19.0	2.5	1.7		
10	10.5–12.5	2.5	1.5		
10	10.0–12.0	3.0	1.5		
10	13.0–15.0	3.0	1.5		
10	18.0–20.0	3.0	1.5		
10	21.0–23.0	3.0	1.5		
	± 1.0	± 0.5	0.3	± 1.0	± 1.0

Lead comfiguration:K



⌀D	C	B	E	F	G	A	H
8	13.5–15.5	3	1.2	1.8	0.8	10–20	3.0–5.0
10	18.5–20.5	3	1.2	1.8	1	10–25	
10	19.0–21.0	3	1.5	1.4	0.5		
	± 1.0	± 0.5	± 0.3	± 0.3	± 0.3	± 1.0	± 1.0